

Measurement condition

Ambient temperature:	23	°C
Input power level:	0	dBm
Terminating impedance: *		
Input:	350 Ω -3.8 pF	
Output:	350 Ω -3.8 pF	

Characteristics

Remark:

The reference level for the relative attenuation a_{rel} of the TFS 243E is the minimum of the pass band attenuation a_{min} . The minimum of the pass band attenuation a_{min} is defined as the insertion loss a_e . The centre frequency f_c is the arithmetic mean value of the upper and lower frequencies at the dB filter attenuation level relative to the insertion loss a_e . The nominal frequency f_N is fixed at 243.0 MHz without any tolerance. The given values for both the relative attenuation a_{rel} and the group delay ripple have to be achieved at the frequencies given below even if the centre frequency f_c is shifted due to the temperature coefficient of frequency TC_f in the operating temperature range and due to a production tolerance for the centre frequency f_c .

D a t a		typ. value	tolerance / limit
Insertion loss (reference level)	a_e	1.35 dB	max. 2.5 dB
Nominal frequency	f_N	-	243.0 MHz
Centre frequency at ambient temperature	f_c	243.0 MHz	242.9...243.1 MHz
Passband	PB		$f_N \pm 25$ kHz
Pass band ripple		0.15 dB	max. ± 0.5 dB
Bandwidth	BW		
0.5 dB		-	min. ± 25 kHz
3 dB		440 KHz	-
Relative attenuation	a_{rel}		
$f_N \pm 0.50$ MHz ... $f_N \pm 1.00$ MHz		15 dB	min. 7 dB
$f_N \pm 1.00$ MHz ... $f_N \pm 3.00$ MHz		30 dB	min. 25 dB
$f_N \pm 3.00$ MHz ... $f_N \pm 5.00$ MHz		37 dB	min. 25 dB
$f_N \pm 5.00$ MHz ... $f_N \pm 8.00$ MHz		43 dB	min. 25 dB
$f_N \pm 8.00$ MHz ... $f_N \pm 20.00$ MHz		48 dB	min. 40 dB
Input power level		-	max. 15 dBm
Operating temperature range	OTR	-	-40 °C ... +85 °C
Storage temperature range		-	-45 °C ... +90 °C
Frequency inversion temperature	T_o	+28 °C	-
Temperature coefficient of frequency	TC_f^{**}	-0.032 ppm/K ²	-

*) The terminating impedances depend on parasitics and q-values of matching elements and the board used, and are to be understood as reference values only. Should there be additional questions do not hesitate to ask for an application note or contact our design team.

***) $\Delta f_c(\text{Hz}) = TC_f (\text{ppm/K}^2) \times (T - T_o)^2 \times f_{T0} (\text{MHz})$

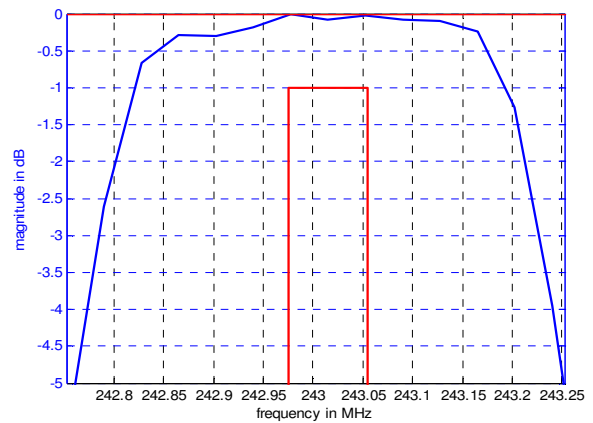
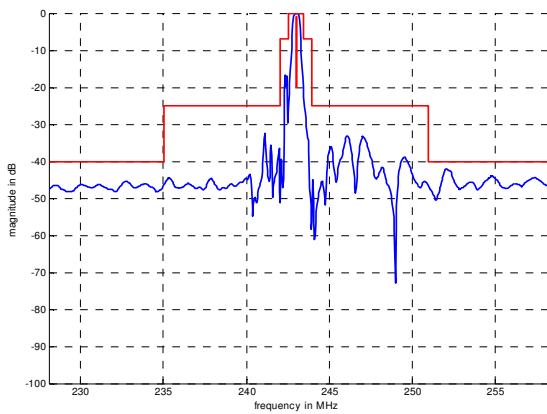
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Checked / Approved:

Vectron International GmbH
Potsdamer Straße 18
D 14 513 TELTOW / Germany
Tel: (+49) 3328 4784-0 / Fax: (+49) 3328 4784-30
E-Mail: tft@vectron.com

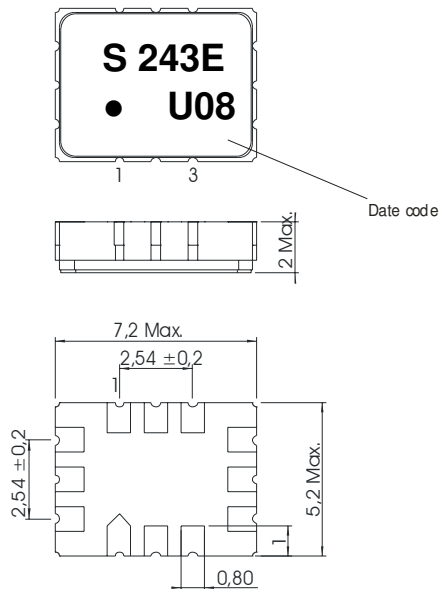
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Filter characteristic



Construction and pin connection

(All dimensions in mm)

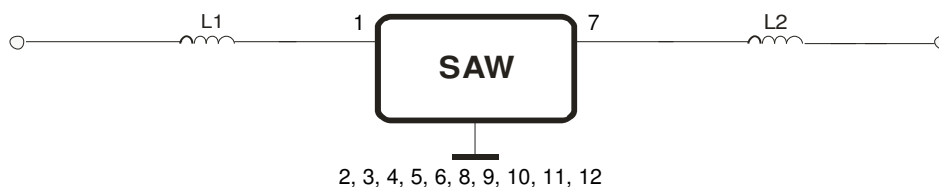


1	Input
2	Ground
3	Ground
4	Ground
5	Ground
6	Ground
7	Output
8	Ground
9	Ground
10	Ground
11	Ground
12	Ground

Date code: Year + week

U	2006
V	2007
W	2008
...	

50 Ω Test circuit



Vectron International GmbH
 Potsdamer Straße 18
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 E-Mail: tft@vectron.com

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Stability characteristics, reliability

After the following tests the filter shall meet the whole specification:

1. Shock: 500g, 1 ms, half sine wave, 3 shocks each plane;
DIN IEC 68 T2 - 27
2. Vibration: 10 Hz to 500 Hz, 0,35 mm or 5 g respectively, 1 octave per min, 10 cycles per plan, 3 plans;
DIN IEC 68 T2 - 6
3. Change of temperature: -55 °C to 125°C / 30 min. each / 10 cycles
DIN IEC 68 part 2 – 14 Test N
4. Resistance to solder heat (reflow): reflow possible: twice max.;
for temperature conditions refer to the attached "Air reflow temperature conditions" on page 4;

This filter is RoHS compliant (2002/95/EG, 2005/618/EG)

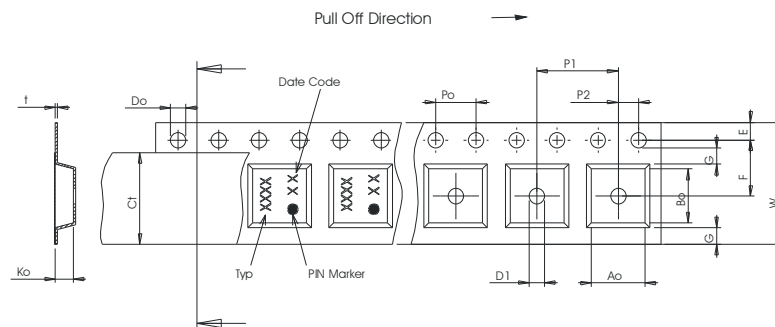
Packing

Tape & Reel: IEC 286 – 3, with exception of value for N and minimum bending radius;
tape type II, embossed carrier tape with top cover tape on the upper side;

max. pieces of filters per reel: 3000
 reel of empty components at start: min. 300 mm
 reel of empty components at start including leader: min. 500 mm
 trailer: min. 300 mm

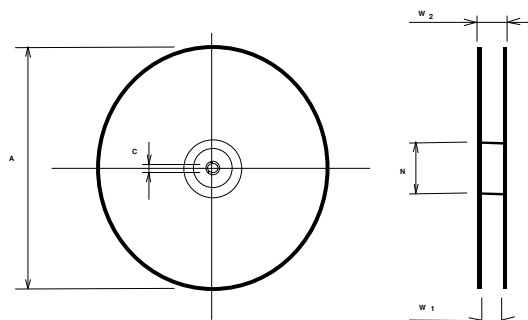
Tape (all dimensions in mm)

- W : 16,00 ± 0,3
- Po : 4,00 ± 0,1
- Do : 1,50 +0,1/-0
- E : 1,75 ± 0,1
- F : 7,50 ± 0,1
- G(min) : 0,60
- P2 : 2,00 ± 0,1
- P1 : 8,00 ± 0,1
- D1(min) : 1,50
- Ao : 5,50 ± 0,1
- Bo : 7,50 ± 0,1
- Ct : 13,5 ± 0,1



Reel (all dimensions in mm)

- A : 330
- W1 : 16,4 +2/-0
- W2(max) : 22,4
- N(min) : 50
- C : 13,0 +0,5/-0,2



The minimum bending radius is 45 mm.

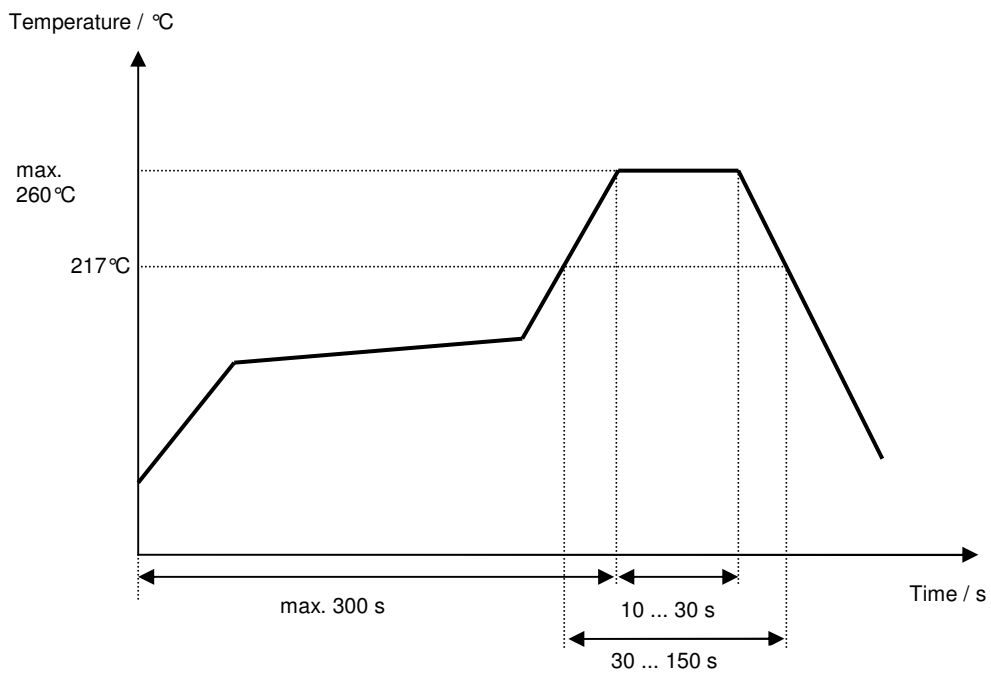
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Tel: (+49) 3328 4784-0 / Fax: (+49) 3328 4784-30
E-Mail: tft@vectron.com

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Air reflow temperature conditions

Conditions	Exposure
Average ramp-up rate (30°C to 217°C)	less than 3°C/second
> 100°C	between 300 and 600 seconds
> 150°C	between 240 and 500 seconds
> 217°C	between 30 and 150 seconds
Peak temperature	max. 260°C
Time within 5°C of actual peak temperature	between 10 and 30 seconds
Cool-down rate (Peak to 50°C)	less than 6°C/second
Time from 30°C to Peak temperature	no greater than 300 seconds

Chip-mount air reflow profile



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History

Version	Reason of Changes	Name	Date
1.0	- Generation of development specification	Strehl	27.07.2005
1.1	- Add bandwidth@1dB	Strehl	30.08.2005
1.2	- Generation of filter specification and add of typical values	Sabah	27.10.2005
1.3	- Change insertion loss, bandwidth and relative attenuation	Strehl	08.02.2006
1.4	- Change stability characteristics - Correct relative attenuation	Strehl	16.02.2006
1.5	- Correct filter characteristic	Strehl	21.02.2006
2.0	- Centre frequency at ambient temperature including tolerances added - Frequency inversion temperature added to data table	Schönbein	03.02.2015